

10073600

1016 etch\$3 near3 (bottom (other adj side)) near3 (wafer substrate)
38692 ((2nd second) adj2 (trench groove via)) (etch\$3 near3 (bottom
(other adj side)) near3 (wafer substrate))
16 ((2nd second) adj2 (trench groove via)) same (etch\$3 near3 (bo
ttom (other adj side)) near3 (wafer substrate))
208663 connect\$3 adj2 (trench via groove)
715 connect\$3 near4 top near4 bottom near4 (trench via groove)
21 connect\$3 near4 top near4 bottom near4 trench
160 connect\$3 near4 top near4 bottom near4 groove
539 connect\$3 near4 top near4 bottom near4 via
97 (connect\$3 near4 top near4 bottom near4 via) same (substrate w
afer)
63056 throughhole through-hole throughhole
9705 (throughhole through-hole throughhole) same (substrate wafer)
1034 (throughhole through-hole throughhole) same (substrate wafer) a
nd 438/\$.ccls.
498 (connect\$3 align\$4) same (throughhole through-hole throughhole)
same (substrate wafer) and 438/\$.ccls.
43 (connect\$3 align\$4) same (throughhole through-hole throughhole)
same (substrate wafer) and mems
98 (throughhole through-hole throughhole) same (substrate wafer) a
nd mems
35 438/5?.ccls. and (throughhole through-hole throughhole)
2 (connect\$3 near4 top near4 bottom near4 via) and 438/5?.ccls.
47 (connect\$3 near4 top near4 bottom near4 via) and 438/\$.ccls.
1 "4312115".PN.
1 "4900283".PN.
1 "5000811".PN.
1 "5219796".PN.
1 "5272114".PN.
1 "5369060".PN.
1 "5786266".PN.
1 "5858808".PN.
1 "5943591".PN.
1 "5998238".PN.
1 "6124148".PN.